

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com













OMNIMATE Power for IT networks – scalable to 50 kVA

Tailor-made solutions for special requirements

More standard-compliance means fewer compromises: OMNIMATE Power for IT networks has integrated features incorporated as standard across the range. This makes the design-in and approvals process simpler and makes them safer and more reliable in operation.

Results for the application and advantages for the user: unlimited use in 400-V IT systems and touch safety according to IEC 61800-5-1 (+ 5.5 mm). The self-snapping one-handed safety flange enables intuitive and safe usage. Operational reliability is guaranteed by the automatic interlock feature during the plug-in process. In conclusion: You need no additional device covering. The application-oriented design means that no compromises are necessary during the approval process.

General ordering data

Version	PCB plug-in connector, male header, Middle screw flange, THT/THR solder connection, 7.62 mm, Number of poles: 2, 90°, Solder pin length (I): 2.6 mm, tinned, black, Tape
Order No.	<u>2545980000</u>
Туре	SV-SMT 7.62IT/02/90MSF2 2.6SN BK RL
GTIN (EAN)	4050118556018
Qty.	110 pc(s).
Product data	IEC: 1000 V / 41 A UL: 300 V / 40.5 A
Packaging	Tape



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Technical data

Dimensions and weights

Depth	28.3 mm	Depth (inches)	1.114 inch
Height of lowest version	11.4 mm	Net weight	7.8 g

Environmental Product Compliance

REACH SVHC 127-19-5 N,N-

dimethylacetamide,

541-02-6

Decamethylcyclopentasiloxane,

540-97-6

Dodecamethylcyclohexasiloxane,

556-67-2

Octamethylcyclotetrasiloxane,

84-61-7 Dicyclohexyl

phthalate

System specifications

Product family	OMNIMATE Power - series BV/SV 7.62HP	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	7.62 mm
Pitch in inches (P)	0.3 inch	Outgoing elbow	90°
Number of poles	2	Number of solder pins per pole	2
Solder pin length (I)	2.6 mm	Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin dimensions	0.8 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)+ 0,1 mm		L1 in mm	15.24 mm
L1 in inches	0.6 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	safe to back of hand above the printed circuit board
Touch-safe protection acc. to DIN VDE		Volume resistance	-
0470	IP 20		2.00 mΩ
Tightening torque for screw flange, min	. 0.2 Nm	Tightening torque for screw flange, max	c. 0.3 Nm
Plugging force/pole, max.	12 N	Pulling force/pole, max.	7 N

Material data

Insulating material	PA GF HT3	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	I
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	3
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface		Layer structure of solder connection	13 μm Ni / 46 μm Sr
	tinned		matt
Layer structure of plug contact	13 μm Ni / 46 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	130 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	130 °C		



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Technical data

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	41 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	41 A	(Tu=40°C)	41 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	41 A	pollution degree II/2	1,000 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	630 V	pollution degree III/3	630 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	6 kV	class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage		Short-time withstand current resistance	
class/ contamination degree III/3	6 kV		3 x 1s with 420 A
Clearance, min.	6.9 mm	Creepage distance, min.	9.6 mm

Rated data acc. to UL 1059

Institute (cURus)

Certificate No. (cURus)

Rated voltage (Use group B / UL 1059)	300 V
Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group C / UL 1059)	40.5 A
Clearance distance, min.	6.9 mm
Reference to approval values	Specifications are maximum values, details - see approval certificate.

	E60693
Rated voltage (Use group C / UL 1059)	300 V
Rated current (Use group B / UL 1059)	40.5 A
Rated current (Use group D / UL 1059)	10 A
Creepage distance, min.	9.6 mm

Packing

Packaging	Tape	VPE length	0
VPE width	0	VPE height	0
Tape depth (T2)	15.8 mm	Tape width (W)	56 mm
Tape pocket depth (K0)	15.3 mm	Tape pocket height (A0)	28.4 mm
Tape pocket width (B0)	39.06 mm	Tape pocket separation (P1)	36 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	26.2 mm
Tape reel diameter ∅ (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01		



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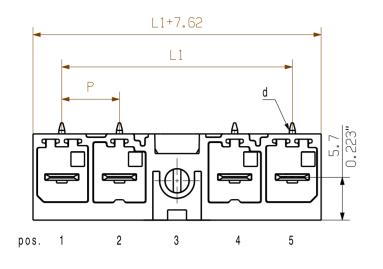
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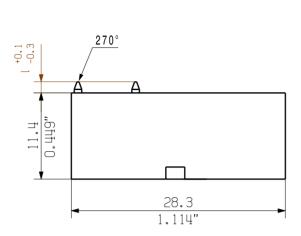
Catalogues

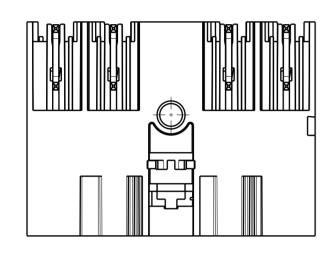
Important note	
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	Additional colours on request
	Rated current related to rated cross-section & min. No. of poles.
	• P on drawing = pitch
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
	 Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months
Approvals	
Approvals	c FAL "us
UL File Number Search	E60693
Downloads	

Catalogues in PDF-format

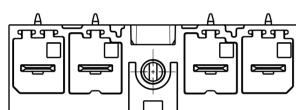
<u>SV-SMT 7.62IT/04/270MF3</u>

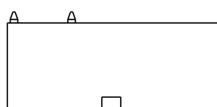


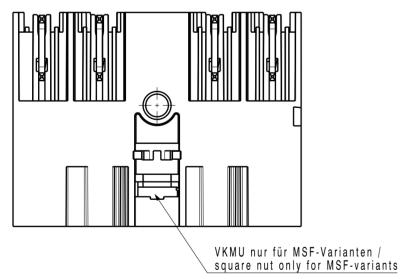


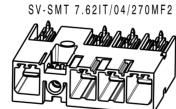


<u>SV-SMT 7.62IT/04/270MSF3</u>



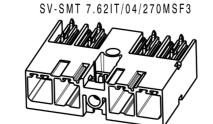






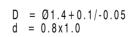












POL = Pol/pole

 $MF = \frac{Mittelflansch}{middle}$

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

corrosive stress will be satisfied.

-⊕

L1+8.5 L1+0.334"

1.28"

40.5 1.594"

hole pattern

paste free area max. dimension

optional

GENERAL TOLERANCE:	
DIN ISO 2768-m	

Scale: 2:1

Drawings Assembly

description	poles	[mm]	[inch]	position MF								
de contratto o	no of	L1	L1	1	2	3	4	5	6	7	8	9
SV 7.62IT/02/M(S)F2 SO	2	15.24	0.60	Pol	MF	Pol						
SV 7.62IT/03/M(S)F2	3	22.86	0.90	PE	MF	Pol	Pol					
SV 7.62IT/03/M(S)F3	- -	30.48	1.20	Pol	Pol	MF	PE					
SV 7.62IT/04/M(S)F2				PE	MF	Pol	Pol	Pol				
SV 7.62IT/04/M(S)F3				Pol	Pol	MF	Pol	Pol				
SV 7.62IT/04/M(S)F4		38.10	1.50	Pol	Pol	Pol	MF	PE				
SV 7.62IT/05/M(S)F2				PE	MF	Pol	Pol	Pol	Pol			
SV 7.62IT/05/M(S)F3) J			Pol	Pol	MF	Pol	Pol	Pol			
SV 7.62IT/05/M(S)F4	5			Pol	Pol	Pol	MF	Pol	Pol			
SV 7.62IT/05/M(S)F5				Pol	Pol	Pol	Pol	MF	PE			

DIN ISO 2768-m				descriptio	II	poles	[mm]	[inch]	position MF						
		EC00002212			Prim PLM Part No.: 225880				Prim ERP Part No.: 2499550000						
ROHS		<u>. </u>	Max. no	c			_		634	456	n		4		
		First Issue Date	Wax. 1105.		Weidmüller			- /2	Drawing no.				Issue n		
14.11.2016			Modif	Modification					Sheet	16	of	17	sheets		
				Date	N a m e										
		Drawn	30.08.2019	Helis, Maria	SV-SMT 7.62HP/IT//90/270										
			Responsible	,	Döhrer, Karl	01	O III I	0.710.71		J U L	, , , ,				

STISTLEISTE MALE HEADER

Size: A2 Approved 09.10.2019 Lang, Thomas Product file: 7407 BLF 7.50HP



without leading pin

PE = Voreilender Kontakt / leading pin

Platine board 270°

Platine 90°

0.167

P = Raster / pitch 7.62

MSF = Mittelschraubflansch middle flange with screw

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and

VKMU nur für MSF-Varianten /

SV-SMT 7.62IT/04/270MF3

SV-SMT 7.62IT/04/270MF4



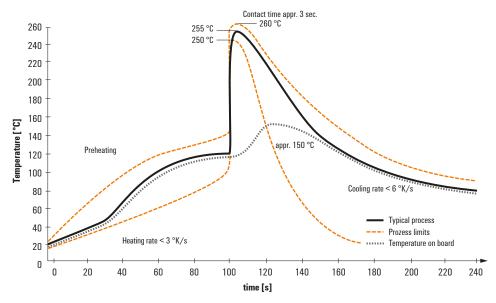
Recommended wave solderding profiles

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Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

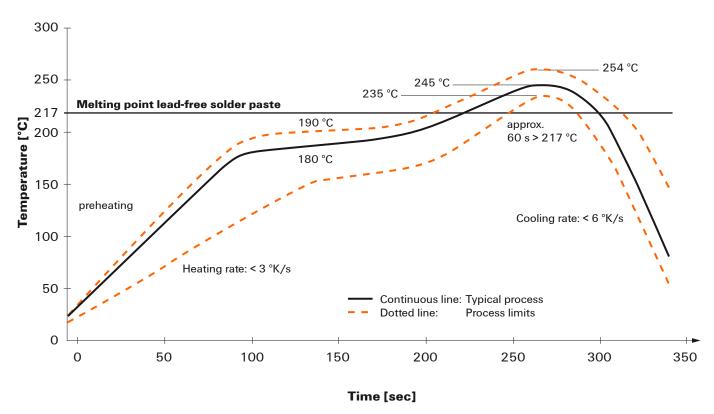


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.